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Mounted Window for 1030nm, 0.80 NA, aplanoXX Aplan Objective

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Mounted Window

Stock **#19-495** **1 In Stock**

1 MRP ₹33,756

! Price inclusive of all taxes

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General

Model Number:
Window in Holder L9333.06 (+D12_515/1030)

Type:
Mounted Window

Note:
Protective window for [#19-491](#)

Physical & Mechanical Properties

Length (mm):

4.40

Clear Aperture CA (mm):

8

Diameter (mm):

29.50

Optical Properties

Design Wavelength DWL (nm):

515, 1030

Wavelength Range (nm):

510 - 545, 1020 - 1100

Damage Threshold, By Design:

25 mJ @5ns

Damage Threshold, Pulsed:

25 mJ @5ns

Regulatory Compliance

RoHS 2015:

Compliant

Certificate of Conformance:

[View](#)

Reach 250:

Compliant

Country of Origin:

Germany

Imported By:

Edmund Optics India Private Limited
267, Greystone Building, Second Floor,
6th Cross Rd, Binnamangala,
Stage 1, Indiranagar, Bengaluru,
Karnataka, India 560038
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Product Details

- Aplanatic Optical Design
- High Numerical Aperture for Small Spot Sizes
- Designs for 800 and 1030nm with Focusing Depth Up to 4mm
- [AdlOptica foXXus Multi-Focus Objectives](#) Also Available

AdlOptica aplanoXX Aplan Objectives compensate for spherical aberration and coma when focusing into glass, sapphire, silicon carbide, silicon, PMMA, and other transparent materials at depths up to 4mm. These objectives are designed to be used with ultrafast solid-state and fiber lasers and are optimized for 800nm (Ti:sapphire) and 1030nm (Yb:doped). Featuring C-Mount threading and an optical design insensitive to misalignment, these objectives are easy to integrate into laser systems. AdlOptica aplanoXX Aplan Objectives are ideal for micromachining glass, 3D nanofabrication, waveguide recording, and selective laser etching. A collar on the objective allows for manual adjustment of focus and a replaceable front window protects from debris during materials processing.

Technical Information

